Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

DATA SHEET

SKY67015-396LF: 30 to 300 MHz Low-Noise, Low-Current Amplifier

Applications

- Military and public safety VHF radios
- General purpose, low power PAs and LNAs
- Wireless sensors
- Automated metering infrastructure

Features

- Low NF: 0.8 dB @ 150 MHz
- Gain: 18.5 dB @ 150 MHz
- Flexible supply voltage from 1.8 to 5.0 V
- Adjustable supply current for higher IIP3
- Improved NF and linearity compared to SiGe LNAs
- Incorporates on-die stability structures
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)

Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

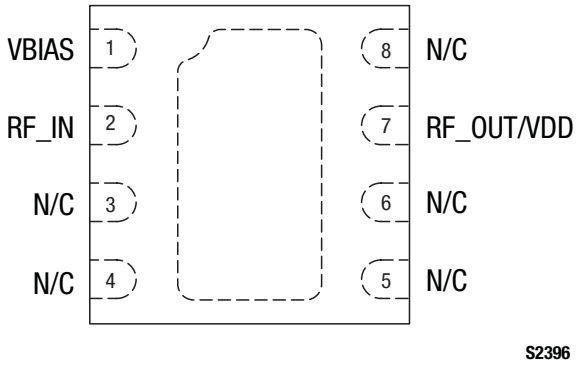


Figure 2. SKY67015-396LF Pinout – 8-Pin DFN (Top View)

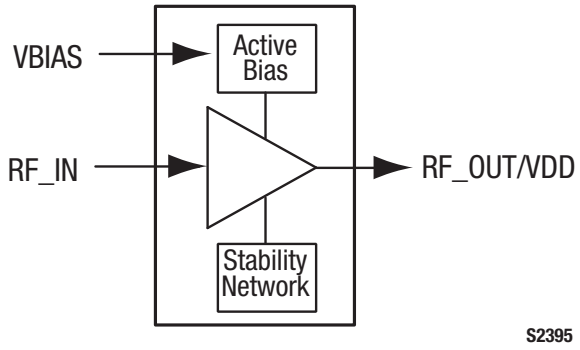


Figure 1. SKY67015-396LF Block Diagram

Description

The SKY67015-396LF is a GaAs, pHEMT low-noise amplifier (LNA) with an integrated active bias. The advanced GaAs pHEMT enhancement mode process provides excellent return loss, low noise, and high linearity.

The SKY67015-396LF is typically used at frequencies ranging from 100 MHz to 300 MHz, The device has been successfully tuned down to 30 MHz with the addition of external RC feedback. Please contact Skyworks for details.

The device offers the ability to externally adjust the supply current. The supply voltage is applied to the RF-OUT/VDD pin through an RF choke inductor. The VBIAS pin should be connected to the RF_OUT/VDD pin through an external resistor to control the supply current. Both RF_OUT/VDD and RF_IN pins should be DC blocked to ensure proper operation.

The SKY67015-396LF is manufactured in a compact, 2 x 2 mm, 8-pin Dual Flat No-Lead (DFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY67015-396LF Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	VBIAS	Bias for first stage amplifier. External resistor sets current consumption.	5	N/C	No connection. May be connected to ground with no change in performance.
2	RF_IN	RF input. DC blocking capacitor required.	6	N/C	No connection. May be connected to ground with no change in performance.
3	N/C	No connection. May be connected to ground with no change in performance.	7	RF_OUT/VDD	RF output. Apply VDD through RF choke inductor. DC blocking capacitor required.
4	N/C	No connection. May be connected to ground with no change in performance.	8	N/C	No connection. May be connected to ground with no change in performance.

Table 2. SKY67015-396LF Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	V_{DD}		5.5	V
Drain current	I_{DD}		40	mA
RF input power	P_{IN}		+18	dBm
Storage temperature	T_{STG}	–65	+125	°C
Operating temperature	T_A	–40	+85	°C
Thermal resistance	Θ_{JC}		128	°C/W
Electrostatic discharge:	ESD			
Charged Device Model (CDM), Class 2			250	V
Human Body Model (HBM), Class 1A			300	V
Machine Model (MM), Class A			30	V

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

***CAUTION**: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.*

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY67015-396LF are provided in Table 2. Electrical specifications are provided in Tables 3 (18 mA operation) and 4 (5 mA operation).

Typical performance characteristics of the SKY67015-396LF are illustrated in Figures 3 through 15.

Table 3. SKY67015-396LF Electrical Specifications: Supply Current = 18 mA (Note 1)
(V_{DD} = 3.3 V, T_A = +25 °C, P_{IN} = –20 dBm, Characteristic Impedance [Z_0] = 50 Ω, Reference Frequency = 250 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure	NF			0.8	1.0	dB
Small signal gain	|S21|		15.5	17.5		dB
Input return loss	|S11|			17		dB
Output return loss	|S22|			17		dB
Reverse isolation	|S12|			24		dB
3rd Order Input Intercept Point	IIP3	Δf = 1 MHz, P_{IN} = –20 dBm/tone	+3.5	+7.5		dBm
3rd Order Output Intercept Point	OIP3	Δf = 1 MHz, P_{IN} = –20 dBm/tone	+21	+25		dBm
1 dB Input Compression Point	IP1dB		–6.5	–4.0		dBm
1 dB Output Compression Point	OP1dB		+10.0	+12.5		dBm
DC Specifications						
Supply voltage	V_{DD}			3.3		V
Quiescent current	I_{DDQ}	Set with external resistor		18		mA

Note 1: Performance is guaranteed only under the conditions listed in this table.

Table 4. SKY67015-396LF Electrical Specifications: Supply Current = 5 mA (Note 1)
(V_{DD} = 3.3 V, T_A = +25 °C, P_{IN} = –20 dBm, Characteristic Impedance [Z_0] = 50 Ω, Reference Frequency = 250 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure	NF			1.05		dB
Small signal gain	|S21|			15.5		dB
Input return loss	|S11|			16		dB
Output return loss	|S22|			14		dB
Reverse isolation	|S12|			23		dB
3rd Order Input Intercept Point	IIP3	Δf = 1 MHz, P_{IN} = –20 dBm/tone		0.5		dBm
3rd Order Output Intercept Point	OIP3	Δf = 1 MHz, P_{IN} = –20 dBm/tone		+16		dBm
1 dB Input Compression Point	IP1dB			–2.5		dBm
1 dB Output Compression Point	OP1dB			+12		dBm
DC Specifications						
Supply voltage	V_{DD}			3.3		V
Quiescent current	I_{DDQ}	Set with external resistor		5		mA

Note 1: Performance is guaranteed only under the conditions listed in this table.

Typical Performance Characteristics

(V_{DD} = 3.3 V, I_{DDQ} = 18 mA, T_A = +25 °C, P_{IN} = –20 dBm, Characteristic Impedance [Z_0] = 50 Ω, Tuning Optimized for 100 MHz to 250 MHz, Unless Otherwise Noted)

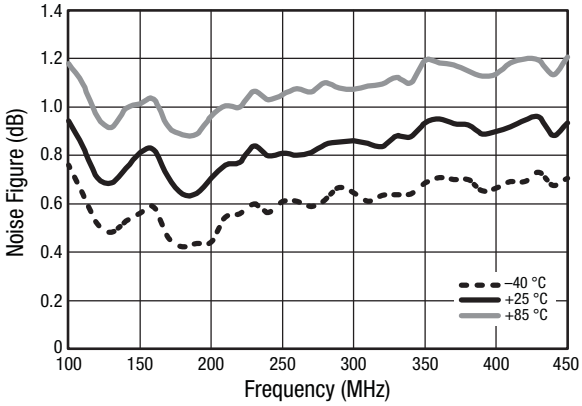


Figure 3. Noise Figure vs Frequency and Temperature, Narrow Band (Includes EVB Insertion Losses)

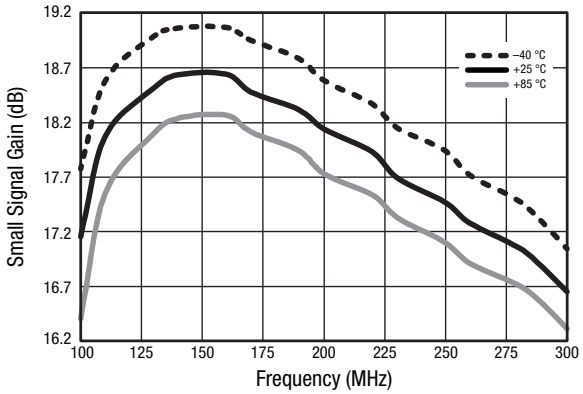


Figure 4. Small Signal Gain (|S21|) vs Frequency and Temperature, Narrow Band

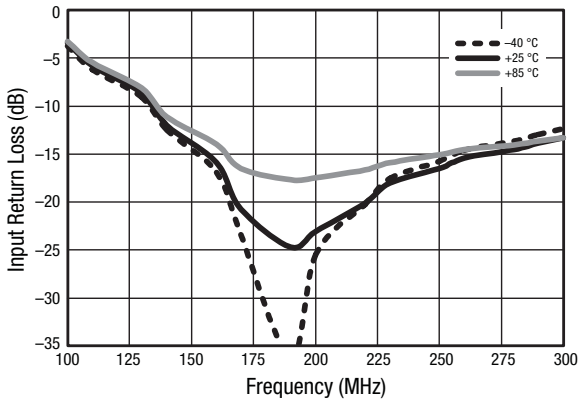


Figure 5. Small Signal Input Return Loss (|S11|) vs Frequency and Temperature, Narrow Band

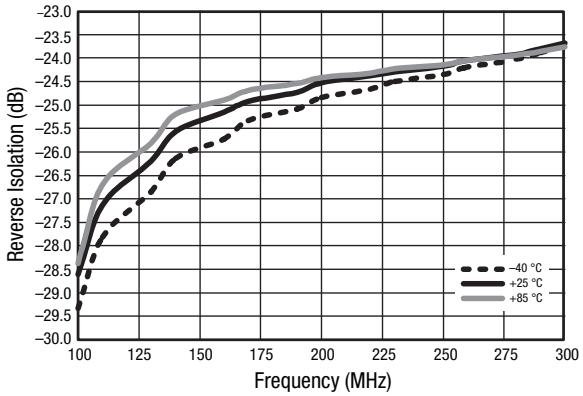


Figure 6. Small Signal Reverse Isolation (|S12|) vs Frequency and Temperature, Narrow Band

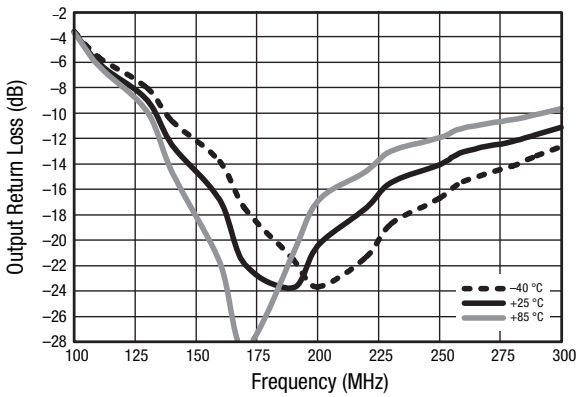


Figure 7. Small Signal Output Return Loss (|S22|) vs Frequency and Temperature, Narrow Band

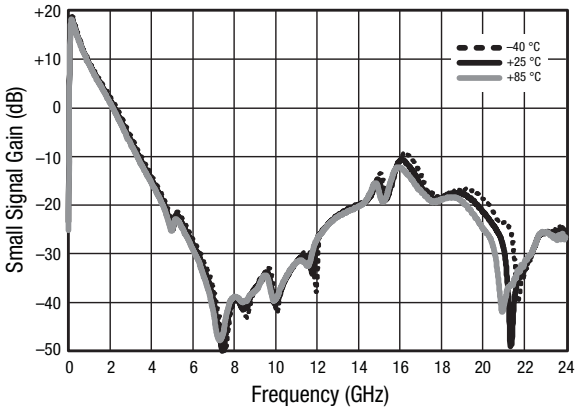


Figure 8. Small Signal Gain (|S21|) vs Frequency and Temperature, Wide Band

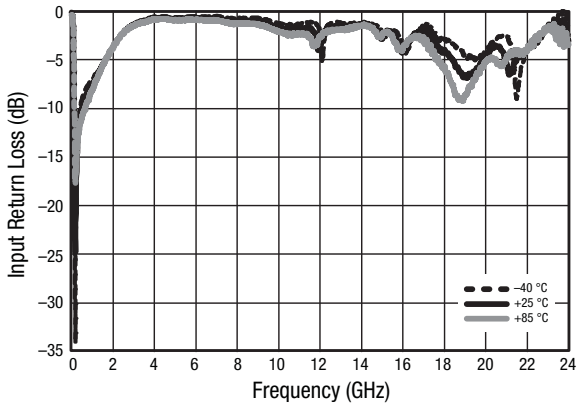


Figure 9. Small Signal Input Return Loss (|S11|) vs Frequency and Temperature, Wide Band

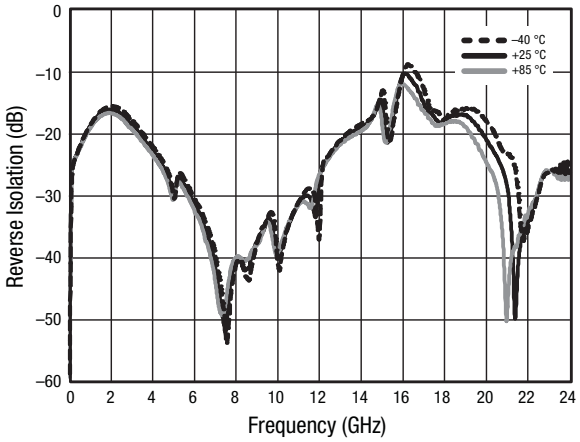


Figure 10. Small Signal Reverse Isolation (|S12|) vs Frequency and Temperature, Wide Band

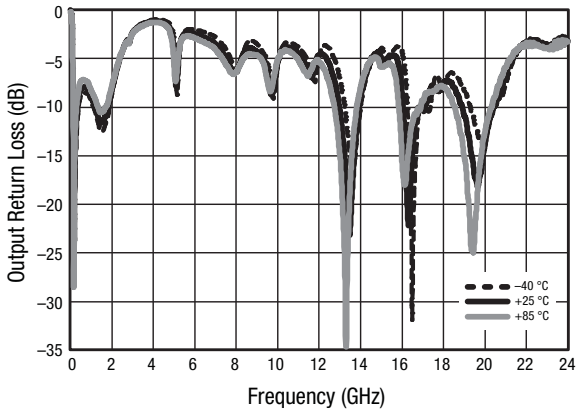


Figure 11. Small Signal Output Return Loss (IS22I) vs Frequency and Temperature, Wide Band

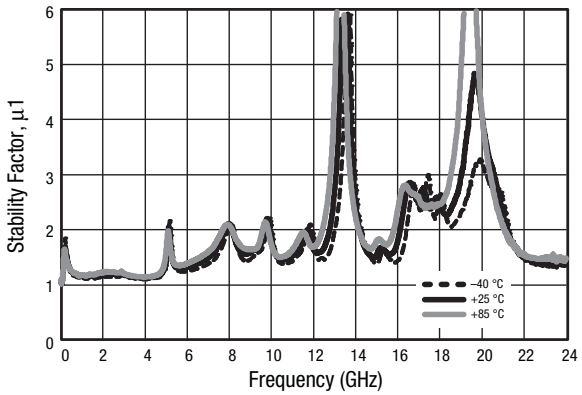


Figure 12. Stability Factor (µ1) vs Frequency and Temperature, Wide Band

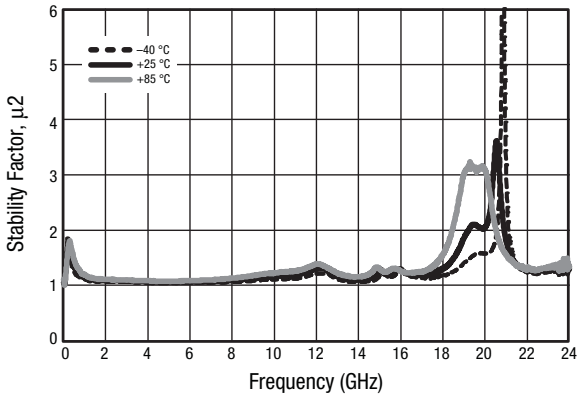


Figure 13. Stability Factor (µ2) vs Frequency and Temperature, Wide Band

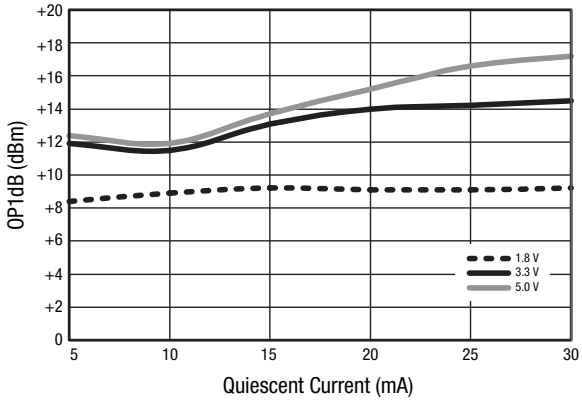


Figure 14. OP1dB vs Quiescent Current

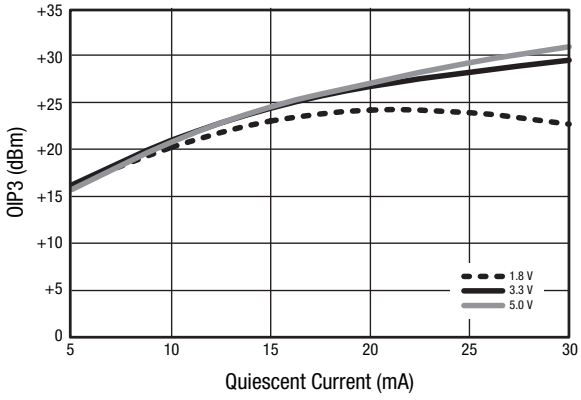


Figure 15. OIP3 vs Quiescent Current

Evaluation Board Description

The SKY67015-396LF Evaluation Board is used to test the performance of the SKY67015-396LF LNA. An assembly drawing for the Evaluation Board is shown in Figure 16. An Evaluation Board schematic diagram is provided in Figure 17. Table 5 provides the Bill of Materials (BOM) list for Evaluation Board components.

Package Dimensions

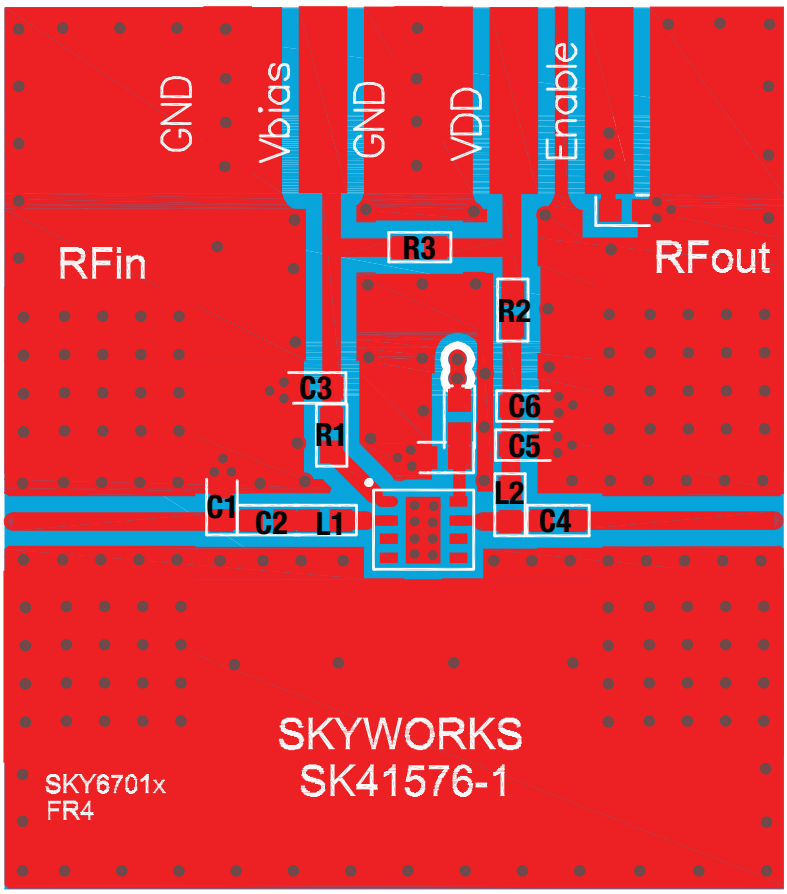
The PCB layout footprint for the SKY67015-396LF is provided in Figure 18. Typical case markings are shown in Figure 19. Package dimensions for the 8-pin DFN are shown in Figure 20, and tape and reel dimensions are provided in Figure 21.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY67015-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



S2394

Figure 16. SKY67015-396LF Evaluation Board Assembly Diagram

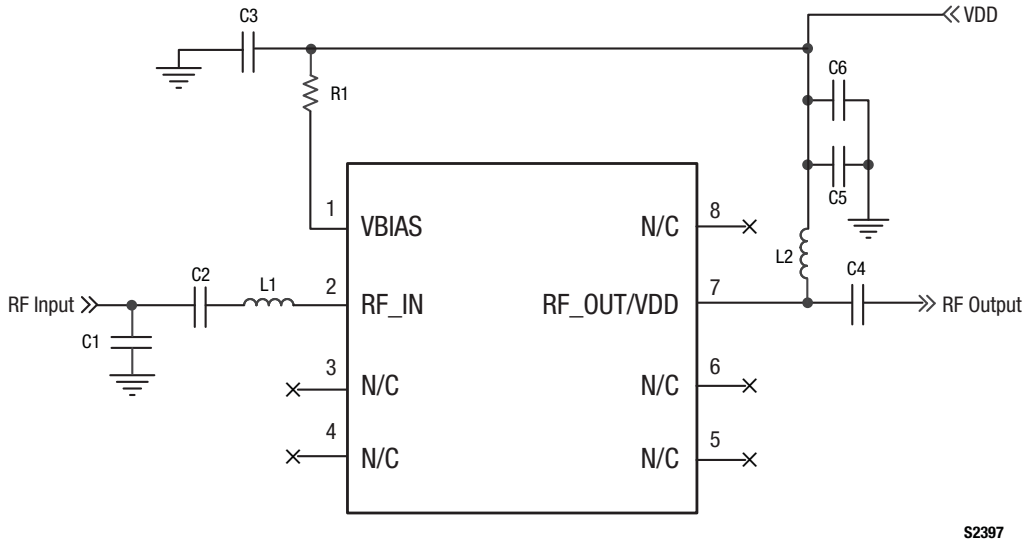


Figure 17. SKY67015-396LF Evaluation Board Schematic

Table 5. SKY67015-396LF Evaluation Board Bill of Materials

Component	Value	Size	Manufacturer	Part Number
C1	DNI	–	–	–
C2, C3	1000 pF	0402	Murata	GRM1555C1H102JA01D
C4	15 pF	0402	Murata	GRM1555C1H150JZ01D
C5	100 pF	0402	Murata	GRM1555C1H101JZ01D
C6	10000 pF	0402	Murata	GRM155R71H103KA88
L1	12 nH	0402	Coilcraft	0402HP-12NX_L
L2	82 nH	0402	Murata	LQG15HS82NJ02D
R1 (Note 1)	4.7 kΩ	0402	Panasonic	ERJ-2GEJ472X

Note 1: Components R2 and R3 shown on the Evaluation Board are 0 Ω jumpers and are not required.

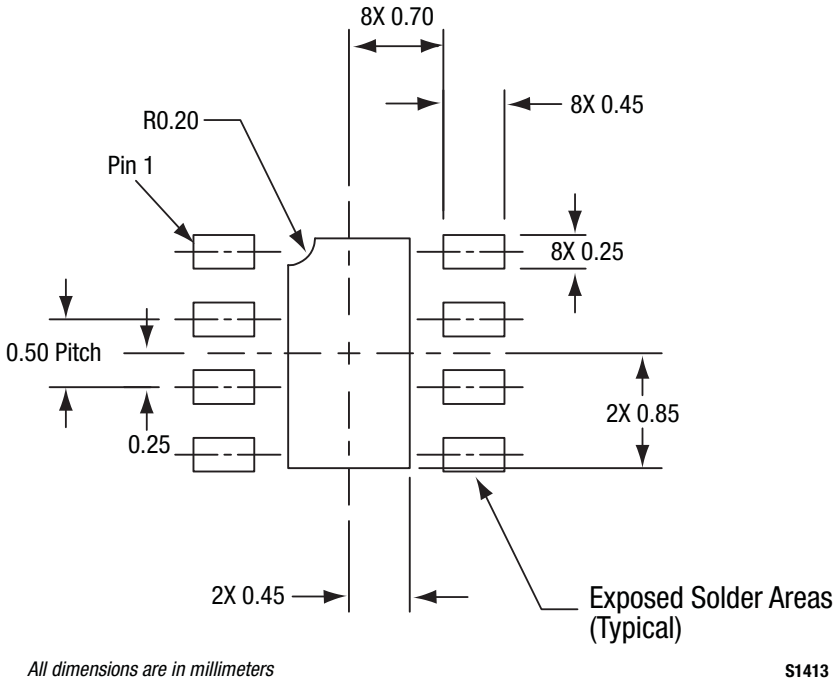


Figure 18. SKY67015-396LF PCB Layout Footprint (Top View)

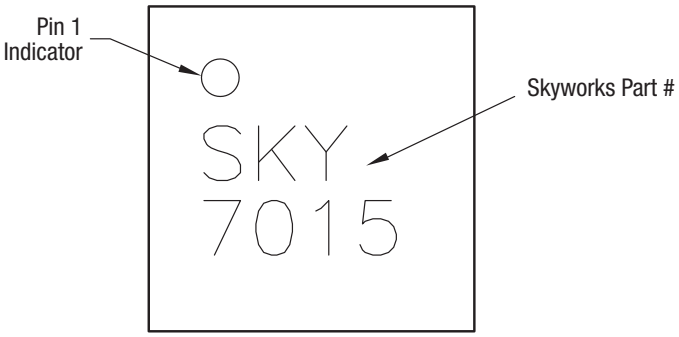
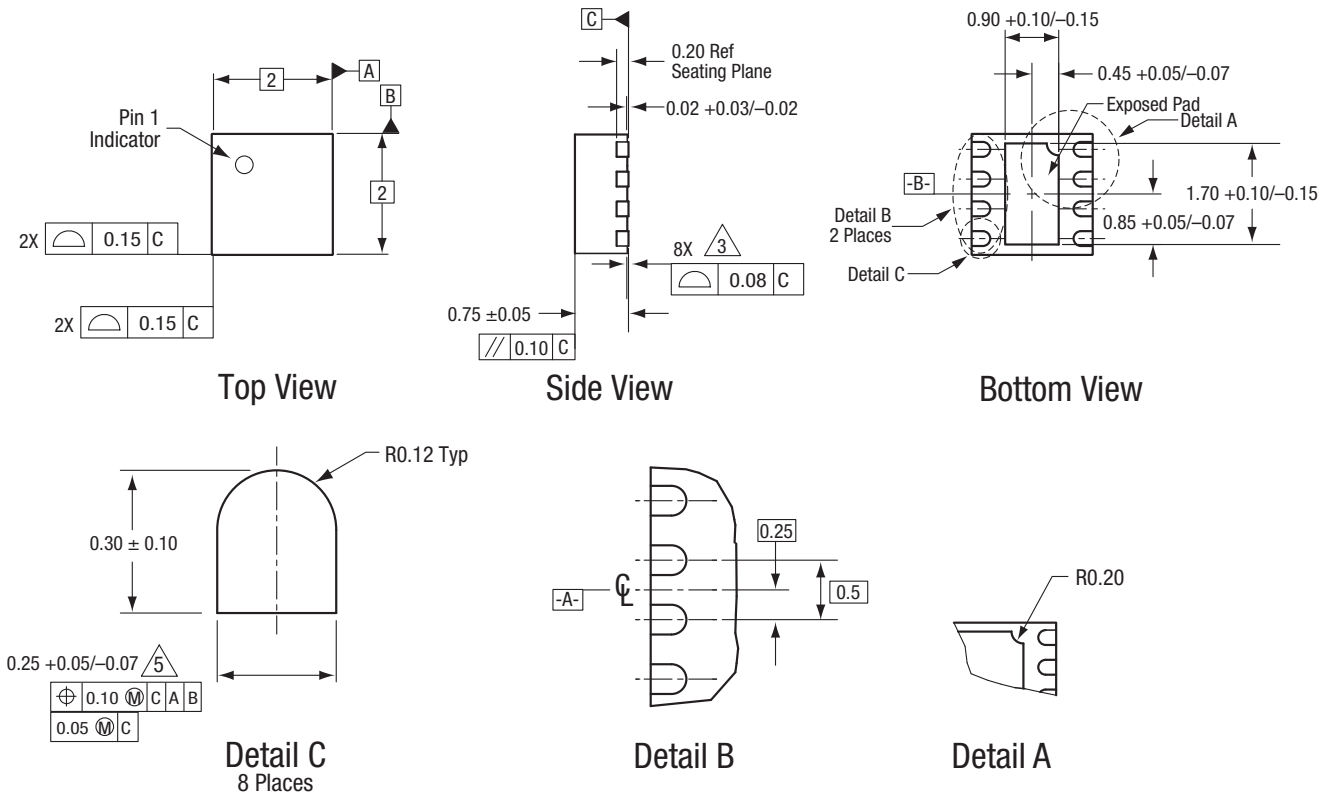


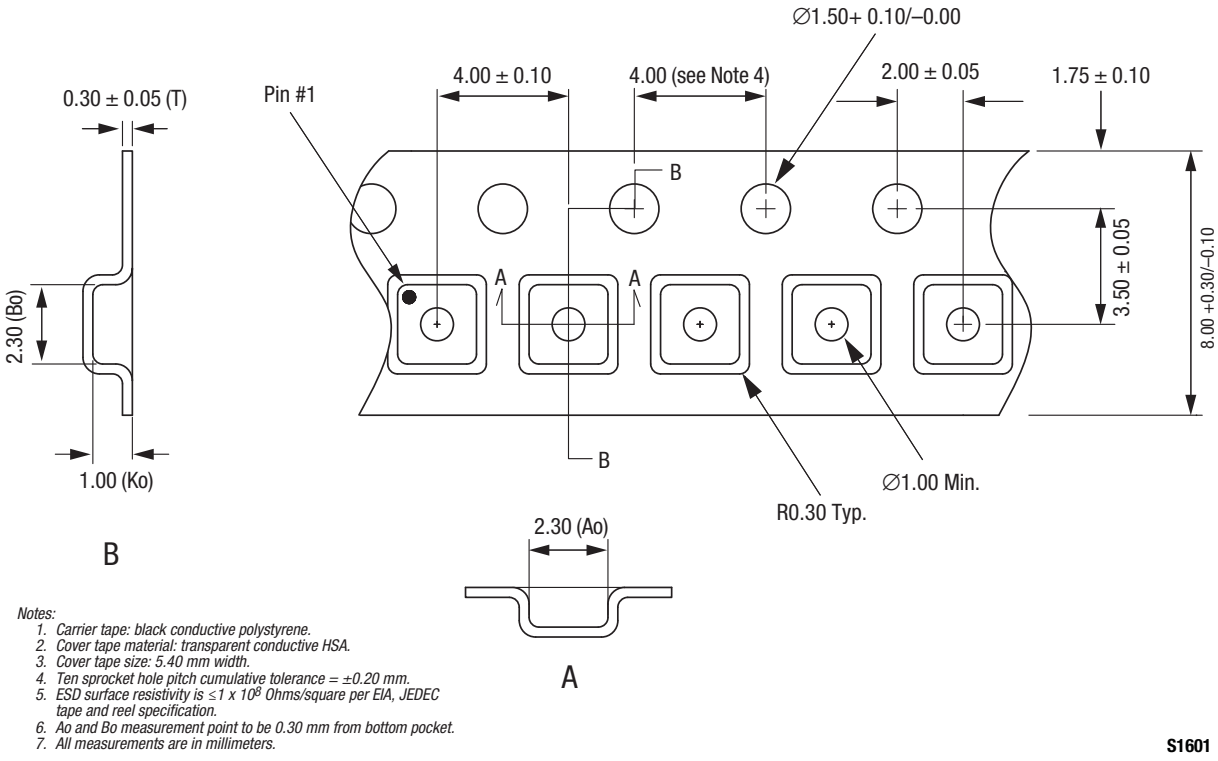
Figure 19. Typical Case Markings (Top View)



All measurements are in millimeters.
Dimensioning and tolerancing according to ASME Y14.5M-1994.
Coplanarity applies to the exposed heat sink slug as well as the terminals..
Plating requirement per source control drawing (SCD) 2504.
Dimension applies to metalized terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.

S1945

Figure 20. SKY67015-396LF 8-Pin DFN Package Dimensions



Notes:
1. *Carrier tape: black conductive polystyrene.*
2. *Cover tape material: transparent conductive HSA.*
3. *Cover tape size: 5.40 mm width.*
4. *Ten sprocket hole pitch cumulative tolerance = ±0.20 mm.*
5. *ESD surface resistivity is ≤1 x 10^9 Ohms/square per EIA, JEDEC tape and reel specification.*
6. *Ao and Bo measurement point to be 0.30 mm from bottom pocket.*
7. *All measurements are in millimeters.*

Figure 21. SKY67015-396LF Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY67015-396LF: Low-Noise, Low-Current Amplifier	SKY67015-396LF	SKY67015-396LF-EVB